

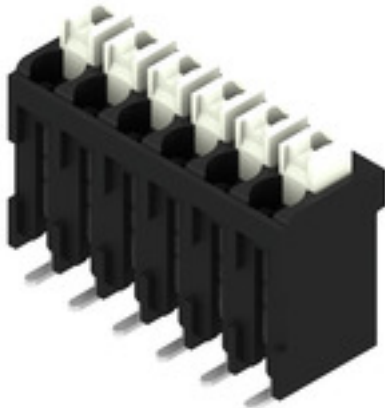
LSF-SMD 3.50/06/180 SN BK RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image**The innovative quick connector - simple, safe and economical:**

PCB terminals with spring connection and direct PUSH IN technology. A milestone in connection technology.

Amazingly simple and simply amazing in practice:

- Connect and easily detach solid wires or wires with wire-end ferrules without using tools
- Processed automatically in the reflow or vapour phase
- Potentials and clamping points marked clearly by coloured push buttons

World-class design-in and processing phases, and suitable for a vast range of applications.

PCB terminal for fully automatic assembly using reflow soldering (SMD), with PUSH IN wire connections. Conductor insertion and slider operation from the same direction (TOP).

- **Solid & flexible conductors with wire-end ferrules need only to be inserted and they are ready.**
- **When connecting stranded wires without wire-end ferrules the actuating element is used to open the terminal point**
- **Intuitive handling – since the wire-entry area and handling area are clearly separated.**
- **Packaged in tape-on-reel**
- **Conductor outlet direction 180°**

General ordering data

Version	Printed circuit board terminals, 3.50 mm, Number of poles: 6, 180°, black, PUSH IN with actuator, Clamping range, max.: 1.5 mm², Tape
Order No.	1250410000
Type	LSF-SMD 3.50/06/180 SN BK RL
GTIN (EAN)	4050118041279
Qty.	180 pc(s).
Product data	IEC: 320 V / 17.5 A / 0.2 - 1.5 mm² UL: 300 V / 12 A / AWG 24 - AWG 14
Packaging	Tape

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Technical data

Dimensions and weights

Depth	10.5 mm	Depth (inches)	0.413 inch
Height	16.3 mm	Height (inches)	0.642 inch
Height of lowest version	16.3 mm	Width	21.7 mm
Width (inches)	0.854 inch	Net weight	5.533 g

Temperatures

Continuous operating temp., max.	120 °C
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System parameters

Product family	OMNIMATE Signal - series LSF	Wire connection method	PUSH IN with actuator
Mounting onto the PCB	SMD solder connection	Conductor outlet direction	180°
Pitch in mm (P)	3.5 mm	Pitch in inches (P)	0.138 "
Number of poles	6	Pin series quantity	1
Fitted by customer	No	Number of rows	1
Coplanarity:	100 µm	Number of solder pins per pole	2
Stripping length	8 mm	L1 in mm	17.5 mm
L1 in inches	0.69 "	Touch-safe protection acc. to DIN VDE 0470	IP 20
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Protection degree	IP20
Volume resistance	1.60 mΩ		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Layer structure of solder connection	4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
Wire connection cross section AWG, min.	AWG 28
Wire connection cross section AWG, max.	AWG 14
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, 0.25 mm ² min.	
w. plastic collar ferrule, DIN 46228 pt 4, 0.75 mm ² max.	
w. wire end ferrule, DIN 46228 pt 1, min.	0.25 mm ²
w. wire end ferrule, DIN 46228 pt 1, max.	1.5 mm ²

Creation date July 15, 2024 8:16:56 AM CEST

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Clampable conductor	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.25 mm ²	
	wire end ferrule	Stripping length	nominal	10 mm
		Recommended wire-end ferrule	H0.25/12 HBL	
	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.34 mm ²	
	wire end ferrule	Stripping length	nominal	10 mm
		Recommended wire-end ferrule	H0.34/12 TK	
	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.5 mm ²	
	wire end ferrule	Stripping length	nominal	10 mm
		Recommended wire-end ferrule	H0.5/14 OR	
	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.75 mm ²	
	wire end ferrule	Stripping length	nominal	10 mm
		Recommended wire-end ferrule	H0.75/14T HBL	

Reference text Length of ferrules is to be chosen depending on the product and the rated voltage., The outside diameter of the plastic collar should not be larger than the pitch (P)

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	17.5 A
Rated current, max. number of poles (Tu=20°C)	16 A	Rated current, min. number of poles (Tu=40°C)	17.5 A
Rated current, max. number of poles (Tu=40°C)	14 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1664286
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section, AWG, max.	AWG 14
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

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Technical data

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated current (Use group B / UL 1059) 12 A

Wire cross-section, AWG, min. AWG 24

Reference to approval values Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group D / UL 1059) 10 A

Wire cross-section, AWG, max. AWG 14

Packing

ESD Level packaging	static dissipative
VPE length	396 mm
VPE height	66 mm
Tape width (W)	56 mm
Tape pocket height (A0)	11.2 mm
Tape pocket separation (P1)	20 mm
Tape pocket separation (F)	26.2 mm
Surface resistance	$R_s = 10^9 - 10^{12} \Omega$
Length Pick & Place Pad (L _{PPP})	8.5 mm

Packaging	Tape
VPE width	362 mm
Tape depth (T2)	17.6 mm
Tape pocket depth (K0)	17.1 mm
Tape pocket width (B0)	43.7 mm
Tape hole separation (E)	1.75 mm
Tape reel diameter ϕ (A)	330 mm
Width Pick & Place Pad (W _{PPP})	7.5 mm
Diameter of the withdrawal surface (ϕ D _{max})	9 mm

Type tests

Test: Durability of markings	Test	mark of origin, type identification, pitch, approval marking UL, durability
Test: Clampable cross section	Standard	DIN EN 60999-1 section 7 and 9.1 / 12.00, DIN EN 60947-1 section 8.2.4.5.1 / 12.02
	Conductor type	Type of conductor and solid 0.14 mm ² conductor cross-section
		Type of conductor and stranded 0.14 mm ² conductor cross-section
		Type of conductor and solid 1.5 mm ² conductor cross-section
		Type of conductor and stranded 1.5 mm ² conductor cross-section
		Type of conductor and AWG 24/1 conductor cross-section
		Type of conductor and AWG 22/19 conductor cross-section
		Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed

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Test for damage to and accidental loosening of conductors	Standard	DIN EN 60999-1 section 9.4 / 12.00
	Requirement	0.2 kg
	Conductor type	Type of conductor and AWG 24/1 conductor cross-section
		Type of conductor and AWG 24/19 conductor cross-section
	Evaluation	passed
	Requirement	0.3 kg
	Conductor type	Type of conductor and stranded 0.25 mm ² conductor cross-section
		Type of conductor and solid 0.5 mm ² conductor cross-section
	Evaluation	passed
	Requirement	0.4 kg
Pull-out test	Conductor type	Type of conductor and solid 1.5 mm ² conductor cross-section
		Type of conductor and stranded 1.5 mm ² conductor cross-section
	Conductor type	Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed
	Standard	DIN EN 60999-1 section 9.5 / 12.00
	Requirement	≥10 N
	Conductor type	Type of conductor and AWG 24/1 conductor cross-section
		Type of conductor and AWG 24/19 conductor cross-section
	Evaluation	passed
	Conductor type	Type of conductor and stranded 0.25 mm ² conductor cross-section
		Type of conductor and H05V-U0.5 conductor cross-section
	Evaluation	passed
	Requirement	≥20 N
	Conductor type	Type of conductor and H07V-U1.5 conductor cross-section
		Type of conductor and H07V-K1.5 conductor cross-section
	Conductor type	Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed
	Requirement	≥40 N
	Conductor type	Type of conductor and H07V-U1.5 conductor cross-section
		Type of conductor and H07V-K1.5 conductor cross-section
	Conductor type	Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed
	Requirement	≥40 N
	Conductor type	Type of conductor and H07V-U1.5 conductor cross-section
		Type of conductor and H07V-K1.5 conductor cross-section
	Conductor type	Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed

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Classifications

ETIM 6.0	EC002643	ETIM 7.0	EC002643
ETIM 8.0	EC002643	ETIM 9.0	EC002643
ECLASS 9.0	27-44-04-01	ECLASS 9.1	27-44-04-01
ECLASS 10.0	27-44-04-01	ECLASS 11.0	27-46-01-01
ECLASS 12.0	27-46-01-01	ECLASS 13.0	27-46-01-01

Environmental Product Compliance

REACH SVHC	/
RoHS Compliance Status	Compliant without exemption

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	<ul style="list-style-type: none"> • Additional push button colours on request • Operating force of slider max. 40 N • Rated current related to rated cross-section & min. No. of poles. • Wire end ferrule with plastic collar to DIN 46228/4 • Wire end ferrule without plastic collar to DIN 46228/1 • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool recommended. • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals	
ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693

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www.weidmueller.com**Technical data****Downloads**Approval/Certificate/Document of Con-
formity[Declaration of the Manufacturer](#)

Engineering Data

[CAD data – STEP](#)

Product Change Notification

[Changeover to ESD bags for "Tape on Reel" products](#)[Umstellung auf ESD-Beutel bei „Tape on Reel“ Produkten](#)

Catalogues

[Catalogues in PDF-format](#)

Brochures

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White paper surface mount technology

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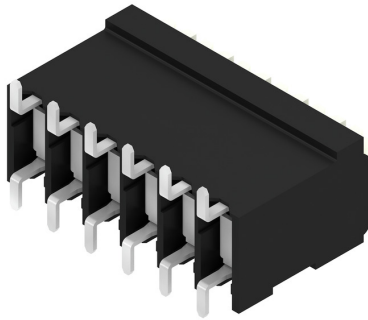
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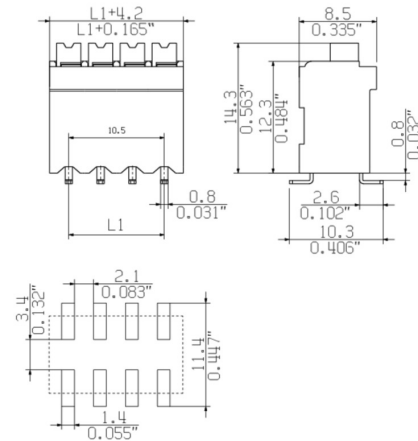
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Drawings

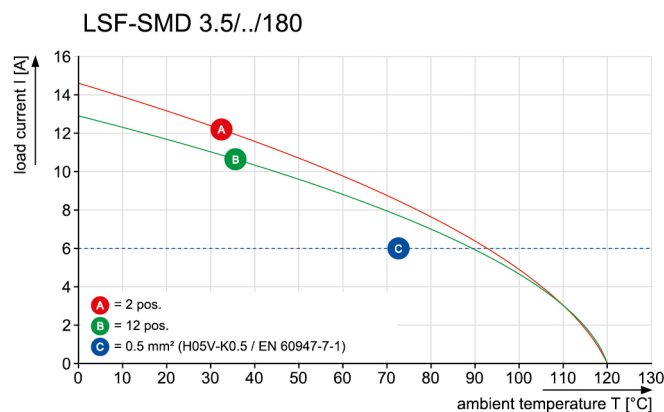
Product image



Dimensional drawing



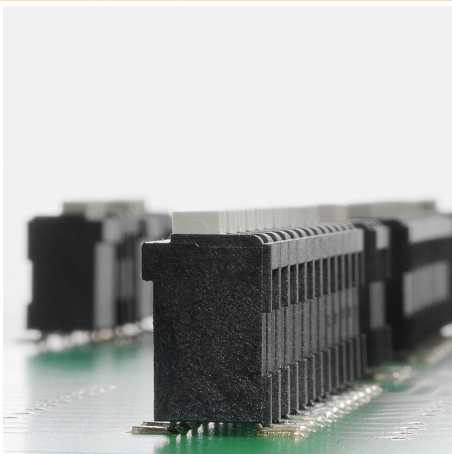
Graph



Graph

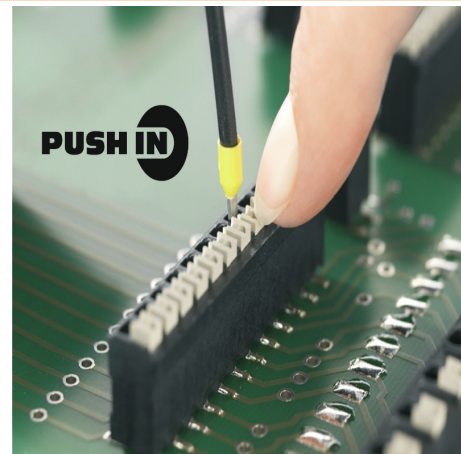


Product benefits



Stable solder connection

Product benefits



PUSH IN wire connection

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Drawings

Product benefits



Packaged in tape-on-reel

Dimensional drawing



Dimensional drawing



Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.